Specification

LC/UPC Receptacle XFP

Optical Transceiver Module

10 Gigabit Ethernet

10GBASE-SR

Ordering Information

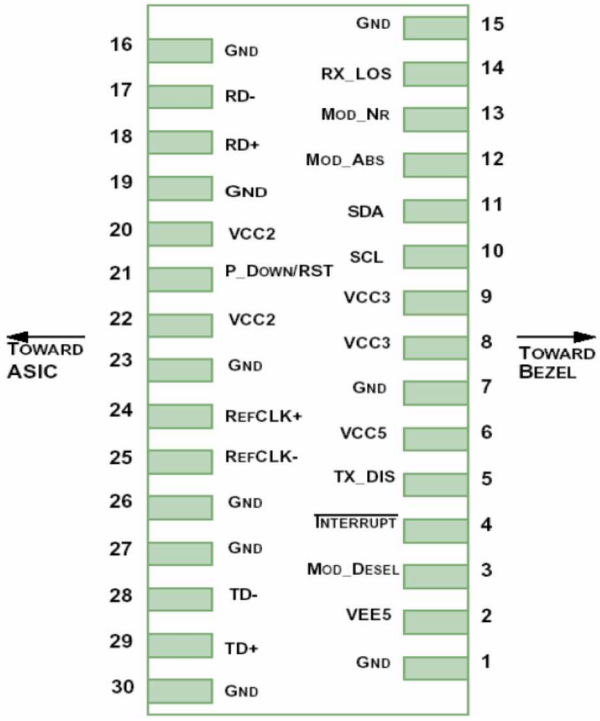
T A S – X 1 X H 5 – B A 6

Model Name	Voltage	Category	Device type	Interface	Temperature	Distance
TAS-X1XH5-BA6	5V, 3.3V, 1.8V	With DDMI	850 nm VCSEL	AC-AC / TTL	0°C ~ +70°C	300 m

Features

- STM64 or 10GBase SR/SW application
- Supports Data rate 9.95 ~ 10.5 Gbps
- Up to 300 m transmission distance over OMA3 MMF
- 850 nm VCSEL Laser transmitter
- 850 nm receiver with PIN-TIA
- 2-wire interface for integrated digital diagnostic Monitoring
- Operation case temperature 0~70°C for commercial
- Single +5V +3.3V +1.8V power supply
- XFP MAS package with LC/UPC receptacle optical interface
- RoHS compliance

Pin Assignment and Pin Description



Pin Definitions

PIN	Logic	Symbol	Name/Description	Note
1		GND	Ground	1
2		VEE5	Optional -5.2V power supply, not in use	3
3	LVTLL-I	Mod_DeSel	Module Deselect; when held low allows module to respond 2-wire serial interface	
4	LVTLL-O	Interrupt	Indicates presence of an important condition which can be read over the 2-wire serial interface	2
5	LVTLL-I	TX_DIS	Transmitter Disable; turn off transmitter laser output	
6		VCC5	+5V power supply, not in use	3
7		GND	Ground	1
8		VCC3	+3.3V power supply	
9		VCC3	+3.3V power supply	
10	LVTTL-I/O	SCL	2-wire serial interface clock	2
11	LVTTL-I/O	SDA	2-wire serial interface data	2
12	LVTTL-O	Mod_Abs	Indicates module is not present. ground in the module	2
13	LVTTL-O	Mod_NR	Module not ready, indicating module operational fault	2
14	LVTTL-O	RX_LOS	Receiver loss of signal indicator	2
15		GND	Ground	1
16		GND	Ground	1
17	CML-O	RD-	Receiver Inverted Data Output	
18	CML-O	RD+	Receiver Non-Inverted Data Output	
19		GND	Ground	1
20		VCC2	+1.8V power supply, not in use	3
21	LVTTL-I	P_Down/RST	Power down; when high, requires the module to limit power consumption to 1.5w or below ,2-wire serial interface must be functional in the low power mode	

			Reset; the falling edge initiates a complete reset of the module including the 2-wire Serial interface, equivalent to a power cycle	
22		VCC2	+1.8V power supply, not in use	3
23		GND	Ground	1
24	PECL-I	RefCLK+	Reference clock non-inverted input, ac coupled on the host board, not in use	3
25	PECL-I	RefCLK-	Reference clock inverted input, ac coupled on the host board, not in use	3
26		GND	Ground	1
27		GND	Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Ground	1

Notes:

1. **Module ground pins GND are isolated from the module case and chassis ground within the module.**
2. **Shall be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.45V on the host board.**
3. **Not connected internally.**

Absolute Maximum Ratings

It has to be noted that the operation in excess of any individual absolute maximum ratings might cause permanent damage to this module.

Parameters	Symbol	Min.	Max.	Unit
Bit Rate	Gbps	9.95	10.5	V
Power Dissipation			1.5	W
Storage Temperature	Ts	-40	85	°C
Operating Case Temperature	Top	0	70	°C

Optical Characteristics

The following optical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min.	Typ.	Max	Unit	Notes
Operating Reach, OM3 MMF				300	m	
Transmitter						
Center Wavelength	λt	840	850	860	nm	
Spectral Width			0.4	0.45	nm	
Average Optical Power	Pavg	-7.3		-1	dBm	
Transmitter and dispersion penalty (max)	TDP			3.2	dB	3
Average launch power of Off transmitter	Poff			-30	dBm	
Extinction Ratio	ER	3			dB	
Transmitter Mask ($PRBS2^{31}$-1@9.95G)		Compliant With ITU-T				
Receiver						
Center Wavelength	λr	840	850	860	nm	
Sensitivity ($PRBS2^{31}$-1@9.95G, BER<10^{-12})				-11.1	dBm	
Overload ($PRBS2^{31}$-1@9.95G, BER<10^{-12})		-1.0			dBm	
Los Assert	LosA	-30			dBm	
Los Dessert	LosD			-12	dBm	
Los Hysteresis	LosH	0.5			dB	

Note:

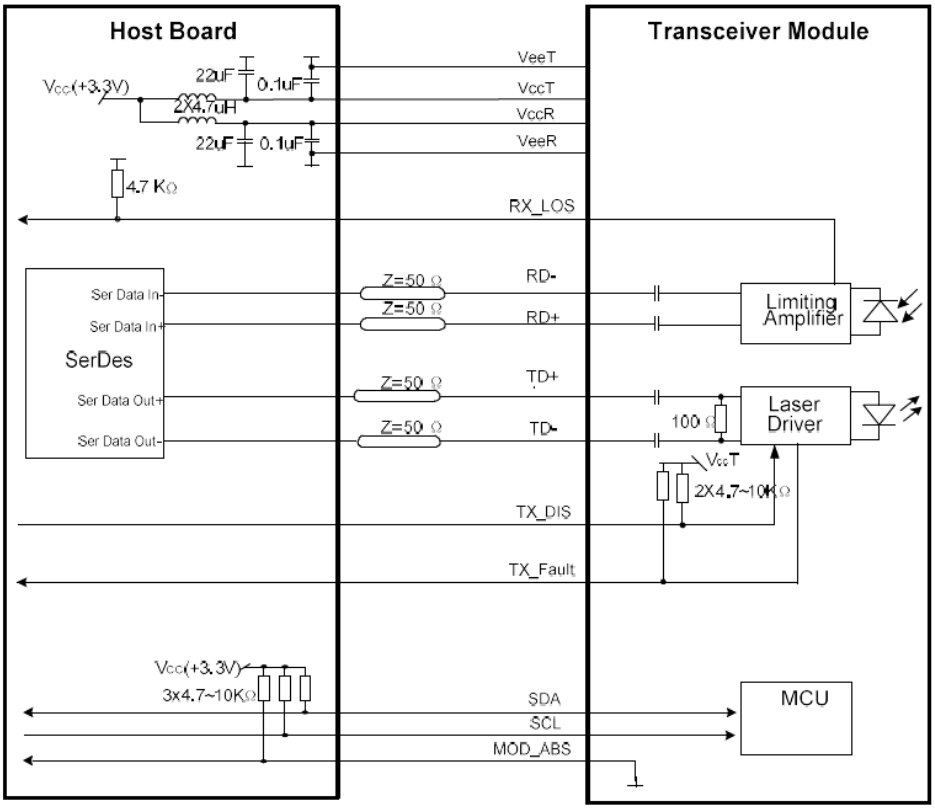
1. **Average optical power shall be measured using the methods specified in TIA/EIA-455-95.**
2. **Receiver sensitivity is informative. Stressed receiver sensitivity shall be measured with conformance test signal for BER =1x 10^{-12} .**
3. **Path penalty is intended as the power penalty of the interface between back-to-back and the maximum applied dispersion.**

Electrical Characteristics

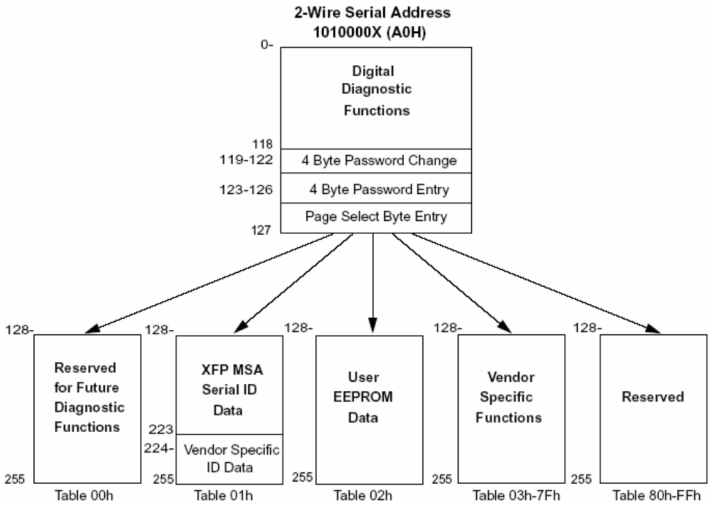
The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min.	Typical	Max	Unit	Notes
Data Rate		9.953		10.5	Gbps	
Data Input Swing Differential/TX		180		1200	mV	
Data Output Swing Differential/RX		300		850	mV	
Date Differential Impedance		90	100	110	Ω	
Output High		2.4		Vcc	V	
Output Low		0		0.4	V	
Input High		2		Vcc+0.3	V	
Input Low		0		0.8	V	
LOS Assert Time	T_{LOSA}			100	us	
LOS De-assert Time	T_{LOSD}			100	us	

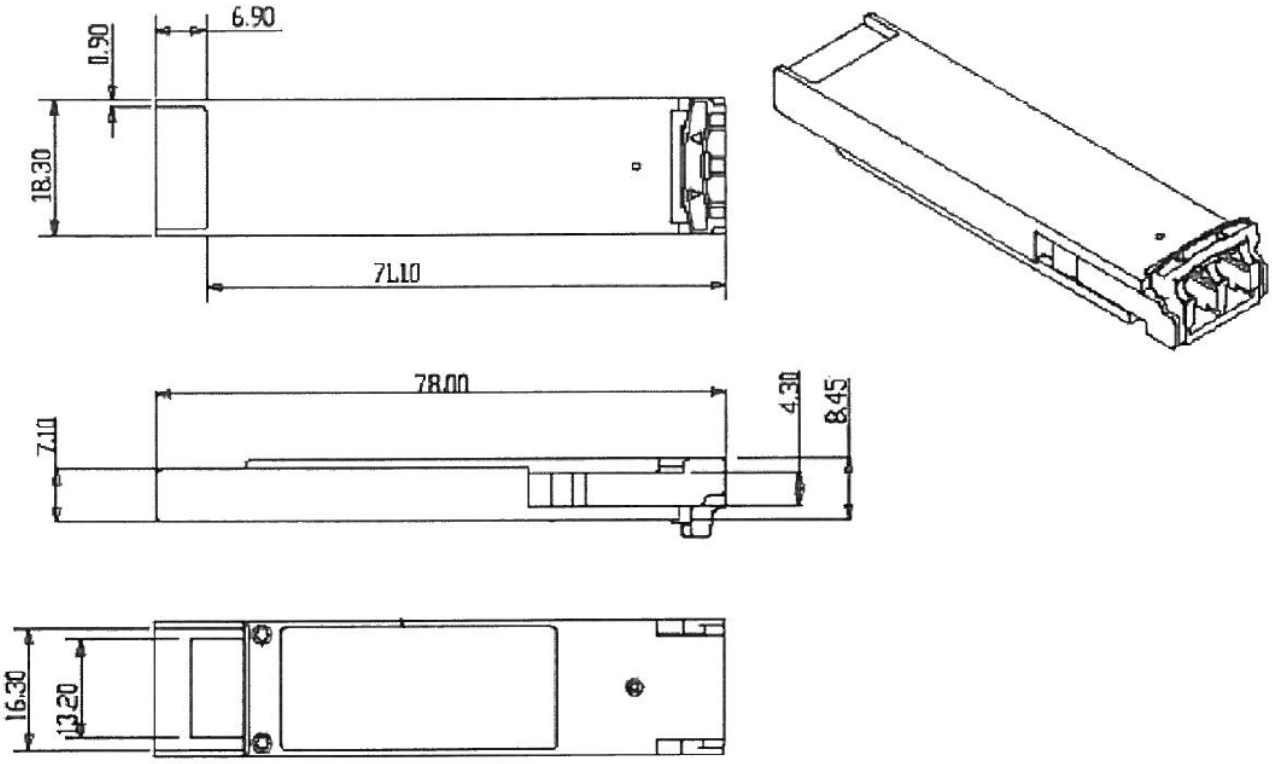
Typical Interface Circuit



EEPROM Memory Map



Mechanical Dimensions



ESD

Normal ESD precautions are required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.

LASER Safety

This is a Class 1 Laser Product according to IEC/EN60825-1:2014 (Third Edition). This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (June 24, 2007)

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